# 2.5V/3.3V Multilevel Input to CML Clock/Data Receiver/Driver/Translator Buffer

### Description

The NBSG16M is a differential current mode logic (CML) receiver/driver/translator buffer. The device is functionally equivalent to the EP16, LVEP16, or SG16 devices with CML output structure and lower EMI capabilities.

Inputs incorporate internal 50  $\Omega$  termination resistors and accept LVNECL (Negative ECL), LVPECL (Positive ECL), LVTTL, LVCMOS, CML, or LVDS. The CML output structure contains internal 50  $\Omega$  source termination resistor to  $V_{CC}$ . The device generates 400 mV output amplitude with 50  $\Omega$  receiver resistor to  $V_{CC}$ .

The  $V_{BB}$  pin is internally generated voltage supply available to this device only. For all single-ended input conditions, the unused complementary differential input is connected to  $V_{BB}$  as a switching reference voltage.  $V_{BB}$  may also rebias AC coupled inputs. When used, decouple  $V_{BB}$  via a 0.01  $\mu F$  capacitor and limit current sourcing or sinking to 0.5 mA. When not used,  $V_{BB}$  output should be left open.

#### **Features**

- Maximum Input Clock Frequency > 10 GHz Typical
- Maximum Input Data Rate > 10 Gb/s Typical
- 120 ps Typical Propagation Delay
- 35 ps Typical Rise and Fall Times
- Positive CML Output with Operating Range:  $V_{CC} = 2.375 \text{ V}$  to 3.465 V with  $V_{EE} = 0 \text{ V}$
- Negative CML Output with RSNECL or NECL Inputs with Operating Range:  $V_{CC}$  = 0 V with  $V_{EE}$  = -2.375 V to -3.465 V
- CML Output Level; 400 mV Peak-to-Peak Output with 50  $\Omega$  Receiver Resistor to  $V_{CC}$
- 50  $\Omega$  Internal Input and Output Termination Resistors
- Compatible with Existing 2.5 V/3.3 V LVEP, EP, LVEL and SG Devices
- V<sub>BB</sub> Reference Voltage Output
- Pb-Free Packages are Available



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#### MARKING DIAGRAM\*



QFN-16 MN SUFFIX CASE 485G



A = Assembly Location

L = Wafer Lot Y = Year W = Work Week ■ Pb-Free Package

(Note: Microdot may be in either location)

\*For additional marking information, refer to Application Note AND8002/D.

#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 9 of this data sheet.

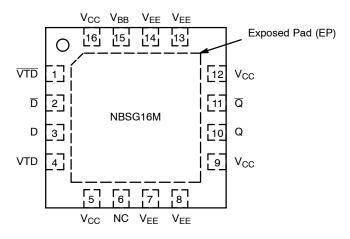


Figure 1. QFN-16 Pinout (Top View)

## **Table 1. PIN DESCRIPTION**

Pin	Name	I/O	Description
1	$\overline{V_{TD}}$	-	Internal 50 $\Omega$ Termination Pin. See Table 2. (Note 3)
2	D	LVDS, CML, ECL, LVTTL, LVCMOS Input	Inverted Differential Input (Note 3)
3	D	LVDS, CML, ECL, LVTTL, LVCMOS Input	Noninverted Differential Input. (Note 3)
4	$V_{TD}$	-	Internal 50 $\Omega$ Termination Pin. See Table 2. (Note 3)
5	V <sub>CC</sub>	-	Positive Supply Voltage. All $V_{\text{CC}}$ pins must be externally connected to Power Supply to guarantee proper operation.
6	NC	-	No Connect (Note 1)
7	V <sub>EE</sub>	-	Negative Supply Voltage. All $V_{\text{EE}}$ pins must be externally connected to Power Supply to guarantee proper operation.
8	V <sub>EE</sub>	-	Negative Supply Voltage. All $V_{\text{EE}}$ pins must be externally connected to Power Supply to guarantee proper operation.
9	V <sub>CC</sub>	-	Positive Supply Voltage. All $V_{\text{CC}}$ pins must be externally connected to Power Supply to guarantee proper operation.
10	Q	CML Output	Noninverted CML Differential Output with Internal 50 $\Omega$ Source Termination Resistor. (Note 2)
11	Q	CML Output	Inverted CML Differential Output with Internal 50 $\Omega$ Source Termination Resistor. (Note 2)
12	V <sub>CC</sub>	-	Positive Supply Voltage. All $V_{CC}$ pins must be externally connected to Power Supply to guarantee proper operation.
13	V <sub>EE</sub>	-	Negative Supply Voltage. All $V_{\text{EE}}$ pins must be externally connected to Power Supply to guarantee proper operation.
14	V <sub>EE</sub>	-	Negative Supply Voltage. All $V_{\text{EE}}$ pins must be externally connected to Power Supply to guarantee proper operation.
15	V <sub>BB</sub>	-	Internally Generated ECL Reference Output Voltage
16	V <sub>CC</sub>	-	Positive Supply Voltage. All $V_{\text{CC}}$ pins must be externally connected to Power Supply to guarantee proper operation.
-	EP	-	Exposed Pad. The thermally exposed pad (EP) on package bottom (see case drawing) must be attached to a heat-sinking conduit.

- The NC pins are electrically connected to the die and MUST be left open.
   CML outputs require 50 Ω receiver termination resistor to V<sub>CC</sub> for proper operation.
   In the differential configuration when the input termination pin (V<sub>TD</sub>, V<sub>TD</sub>) are connected to a common termination voltage, and if no signal is applied then the device will be a presentible to self- assillation. is applied then the device will be susceptible to self-oscillation.

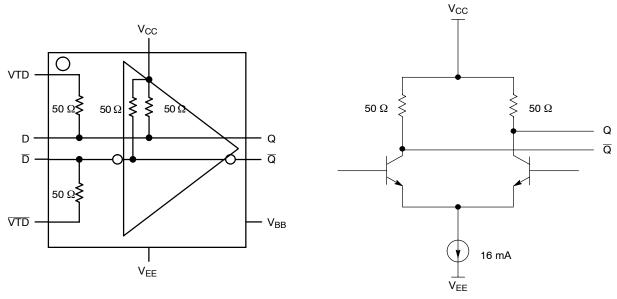


Figure 2. Logic Diagram

Figure 3. CML Output Structure

**Table 2. Interfacing Options** 

INTERFACING OPTIONS	CONNECTIONS
CML	Connect VTD and VTD to V <sub>CC</sub>
LVDS	Connect VTD and VTD together
AC-COUPLED	Bias VTD and VTD Inputs within (V <sub>IHCMR</sub> ) Common Mode Range
RSECL, PECL, NECL	Standard ECL Termination Techniques
LVTTL, LVCMOS	An external voltage should be applied to the unused complimentary differential input.  Nominal voltage 1.5 V for LVTTL and V <sub>CC</sub> /2 for LVCMOS inputs.

**Table 3. ATTRIBUTES** 

Charact	Value				
ESD Protection	> 10	kV 00 V kV			
Moisture Sensitivity, Indefinite	Moisture Sensitivity, Indefinite Time Out of Drypack (Note 4)				
	QFN-16	Level 1	Level 1		
Flammability Rating	Oxygen Index: 28 to 34	UL 94 V-0	@ 0.125 in		
Transistor Count	14	<b>1</b> 5			
Meets or exceeds JEDEC Spe	c EIA/JESD78 IC Latchup Test				

4. For additional Moisture Sensitivity information, refer to Application Note AND8003/D.

**Table 4. MAXIMUM RATINGS** 

Symbol	Parameter	Condition 1	Condition 2	Rating	Unit
V <sub>CC</sub>	Positive Power Supply	V <sub>EE</sub> = 0 V		3.6	٧
V <sub>EE</sub>	Negative Power Supply	V <sub>CC</sub> = 0 V		-3.6	٧
VI	Positive Input Negative Input	V <sub>EE</sub> = 0 V V <sub>CC</sub> = 0 V	$V_{I} \leq V_{CC}$ $V_{I} \geq V_{EE}$	3.6 -3.6	V
V <sub>INPP</sub>	Differential Input Voltage  D - D	$\begin{array}{c} V_{CC} - V_{EE} \geq 2.8 \ V \\ V_{CC} - V_{EE} < 2.8 \ V \end{array}$		2.8  V <sub>CC</sub> – V <sub>EE</sub>	V
I <sub>IN</sub>	Input Current Through $R_T$ (50 $\Omega$ Resistor)	Static Surge		45 80	mA mA
I <sub>out</sub>	Output Current	Continuous Surge		25 50	mA mA
I <sub>BB</sub>	V <sub>BB</sub> Sink/Source			1.0	mA
T <sub>A</sub>	Operating Temperature Range			-40 to +85	°C
T <sub>stg</sub>	Storage Temperature Range			-65 to +150	°C
$\theta_{JA}$	Thermal Resistance (Junction-to-Ambient) (Note 5)	0 lfpm 500 lfpm	QFN-16 QFN-16	42 35	°C/W °C/W
$\theta_{\sf JC}$	Thermal Resistance (Junction-to-Case)	1S2P (Note 5)	QFN-16	4.0	°C/W
T <sub>sol</sub>	Wave Solder Pb Pb-Free	<2 to 3 sec @ 248°C <2 to 3 sec @ 260°C		265 265	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

5. JEDEC standard multilayer board – 1S2P (1 signal, 2 power)

Table 5. DC CHARACTERISTICS, POSITIVE CML OUTPUT  $V_{CC} = 2.5 \text{ V}$ ;  $V_{EE} = 0 \text{ V}$  (Note 6)

			-40°C		25°C						
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I <sub>CC</sub>	Positive Power Supply Current	37	43	51	37	43	51	37	43	51	mA
V <sub>OH</sub>	Output HIGH Voltage (Note 7)	V <sub>CC</sub> - 40	V <sub>CC</sub> -	V <sub>CC</sub>	V <sub>CC</sub> - 40	V <sub>CC</sub> -	V <sub>CC</sub>	V <sub>CC</sub> - 40	V <sub>CC</sub> -	V <sub>CC</sub>	mV
V <sub>OL</sub>	Output LOW Voltage (Note 6)		V <sub>CC</sub> - 400	V <sub>CC</sub> - 330		V <sub>CC</sub> - 400	V <sub>CC</sub> - 330		V <sub>CC</sub> - 400	V <sub>CC</sub> - 330	mV
V <sub>IH</sub>	Input HIGH Voltage (Single-Ended) (Note 8)	V <sub>EE</sub> + 1.275	V <sub>CC</sub> - 1.0*	V <sub>CC</sub>	V <sub>EE</sub> + 1.275	V <sub>CC</sub> - 1.0*	V <sub>CC</sub>	V <sub>EE</sub> + 1275	V <sub>CC</sub> - 1.0*	V <sub>CC</sub>	V
V <sub>IL</sub>	Input LOW Voltage (Single-Ended) (Note 8)	V <sub>EE</sub>	V <sub>CC</sub> - 1.4*	V <sub>IH</sub> - 0.150	V <sub>EE</sub>	V <sub>CC</sub> - 1.4*	V <sub>IH</sub> - 0.150	V <sub>EE</sub>	V <sub>CC</sub> - 1.4*	V <sub>IH</sub> - 0.150	V
$V_{BB}$	ECL Reference Voltage Output	1075	1170	1265	1075	1170	1265	1075	1170	1265	mV
V <sub>IHCMR</sub>	Input HIGH Voltage Common Mode Range (Note 8) (Differential Configuration)	1.2		2.5	1.2		2.5	1.2		2.5	V
R <sub>TIN</sub>	Internal Input Termination Resistor	45	50	55	45	50	55	45	50	55	Ω
R <sub>TOUT</sub>	Internal Output Termination Resistor	45	50	55	45	50	55	45	50	55	Ω
I <sub>IH</sub>	Input HIGH Current (@ V <sub>IH</sub> )		60	100		60	100		60	100	μΑ
I <sub>IL</sub>	Input LOW Current (@ V <sub>IL</sub> )		25	50		25	50		25	50	μΑ

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

<sup>6.</sup> Input and output parameters vary 1:1 with  $V_{CC}$ .  $V_{EE}$  can vary +0.125 V to -0.965 V.

All loading with 50 Ω to V<sub>CC</sub>.
 V<sub>IHCMR</sub> min varies 1:1 with V<sub>EE</sub>, V<sub>IHCMR</sub> max varies 1:1 with V<sub>CC</sub>. The V<sub>IHCMR</sub> range is referenced to the most positive side of the differential input signal.

<sup>\*</sup>Typicals used for testing purposes.

Table 6. DC CHARACTERISTICS, POSITIVE CML OUTPUT  $V_{CC} = 3.3 \text{ V}$ ;  $V_{EE} = 0 \text{ V}$  (Note 9)

			-40°C		25°C						
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I <sub>CC</sub>	Positive Power Supply Current	37	43	51	37	43	51	37	43	51	mA
V <sub>OH</sub>	Output HIGH Voltage (Note 10)	V <sub>CC</sub> - 40	V <sub>CC</sub> - 10	V <sub>CC</sub>	V <sub>CC</sub> - 40	V <sub>CC</sub> - 10	V <sub>CC</sub>	V <sub>CC</sub> - 40	V <sub>CC</sub> - 10	V <sub>CC</sub>	mV
V <sub>OL</sub>	Output LOW Voltage (Note 9)		V <sub>CC</sub> - 400	V <sub>CC</sub> - 330		V <sub>CC</sub> - 400	V <sub>CC</sub> - 330		V <sub>CC</sub> - 400	V <sub>CC</sub> - 330	mV
V <sub>IH</sub>	Input HIGH Voltage (Single-Ended) (Note 11)	V <sub>EE</sub> + 1.275	V <sub>CC</sub> - 1.0*	V <sub>CC</sub>	V <sub>EE</sub> + 1.275	V <sub>CC</sub> - 1.0*	V <sub>CC</sub>	V <sub>EE</sub> + 1.275	V <sub>CC</sub> - 1.0*	V <sub>CC</sub>	V
V <sub>IL</sub>	Input LOW Voltage (Single-Ended) (Note 11)	V <sub>EE</sub>	V <sub>CC</sub> - 1.4*	V <sub>IH</sub> – 0.150	V <sub>EE</sub>	V <sub>CC</sub> - 1.4*	V <sub>IH</sub> – 0.150	V <sub>EE</sub>	V <sub>CC</sub> - 1.4*	V <sub>IH</sub> – 0.150	V
$V_{BB}$	ECL Reference Voltage Output	1875	1970	2065	1875	1970	2065	1875	1970	2065	mV
V <sub>IHCMR</sub>	Input HIGH Voltage Common Mode Range (Note 11) (Differential Configuration)	1.2		3.3	1.2		3.3	1.2		3.3	V
R <sub>TIN</sub>	Internal Input Termination Resistor	45	50	55	45	50	55	45	50	55	Ω
R <sub>TOUT</sub>	Internal Output Termination Resistor	45	50	55	45	50	55	45	50	55	Ω
I <sub>IH</sub>	Input HIGH Current (@ V <sub>IH</sub> )		60	100		60	100		60	100	μΑ
I <sub>IL</sub>	Input LOW Current (@ V <sub>IL</sub> )		25	50		25	50		25	50	μΑ

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

 <sup>9.</sup> Input and output parameters vary 1:1 with V<sub>CC</sub>. V<sub>EE</sub> can vary +0.925 V to -0.165 V.
 10. All loading with 50 Ω to V<sub>CC</sub>.
 11. V<sub>IHCMR</sub> min varies 1:1 with V<sub>EE</sub>, V<sub>IHCMR</sub> max varies 1:1 with V<sub>CC</sub>. The V<sub>IHCMR</sub> range is referenced to the most positive side of the differential input signal.

<sup>\*</sup>Typicals used for testing purposes.

Table 7. DC CHARACTERISTICS, NEGATIVE CML OUTPUT  $V_{CC} = 0 \text{ V}$ ;  $V_{EE} = -3.465 \text{ to } -2.375 \text{ V}$  (Note 12)

			-40°C			25°C			85°C		
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I <sub>CC</sub>	Positive Power Supply Current	37	43	51	37	43	51	37	43	51	mA
V <sub>OH</sub>	Output HIGH Voltage (Note 13)	V <sub>CC</sub> - 40	V <sub>CC</sub> - 10	V <sub>CC</sub>	V <sub>CC</sub> - 40	V <sub>CC</sub> - 10	V <sub>CC</sub>	V <sub>CC</sub> - 40	V <sub>CC</sub> - 10	V <sub>CC</sub>	mV
V <sub>OL</sub>	Output LOW Voltage (Note 12)		V <sub>CC</sub> - 400	V <sub>CC</sub> - 330		V <sub>CC</sub> - 400	V <sub>CC</sub> - 330		V <sub>CC</sub> - 400	V <sub>CC</sub> - 330	mV
V <sub>IH</sub>	Input HIGH Voltage (Single-Ended) (Note 13)	V <sub>EE</sub> + 1.275	V <sub>CC</sub> - 1.0*	V <sub>CC</sub>	V <sub>EE</sub> + 1.275	V <sub>CC</sub> - 1.0*	V <sub>CC</sub>	V <sub>EE</sub> + 1.275	V <sub>CC</sub> - 1.0*	V <sub>CC</sub>	V
V <sub>IL</sub>	Input LOW Voltage (Single-Ended) (Note 13)	V <sub>EE</sub>	V <sub>CC</sub> - 1.4*	V <sub>IH</sub> - 0.150	V <sub>EE</sub>	V <sub>CC</sub> - 1.4*	V <sub>IH</sub> - 0.150	V <sub>EE</sub>	V <sub>CC</sub> - 1.4*	V <sub>IH</sub> - 0.150	V
$V_{BB}$	ECL Reference Voltage Output	-1425	-1330	-1235	-1425	-1330	-1235	-1425	-1330	-1235	mV
V <sub>IHCMR</sub>	Input HIGH Voltage Common Mode Range (Note 14) (Differential Configuration)	V <sub>EE</sub>	+1.2	V <sub>CC</sub>	V <sub>EE</sub>	+1.2	V <sub>CC</sub>	V <sub>EE</sub>	+1.2	V <sub>CC</sub>	V
R <sub>TIN</sub>	Internal Input Termination Resistor	45	50	55	45	50	55	45	50	55	Ω
R <sub>TOUT</sub>	Internal Output Termination Resistor	45	50	55	45	50	55	45	50	55	Ω
I <sub>IH</sub>	Input HIGH Current (@ V <sub>IH</sub> )		60	100		60	100		60	100	μΑ
I <sub>IL</sub>	Input LOW Current (@ V <sub>IL</sub> )		25	50		25	50		25	50	μΑ

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

<sup>12.</sup> Input and output parameters vary 1:1 with V<sub>CC</sub>.

<sup>13.</sup> All loading with 50  $\Omega$  to  $V_{CC}$ .

14.  $V_{IHCMR}$  min varies 1:1 with  $V_{EE}$ ,  $V_{IHCMR}$  max varies 1:1 with  $V_{CC}$ . The  $V_{IHCMR}$  range is referenced to the most positive side of the differential of the control of the control of the differential of the control of the contro tial input signal.
\*Typicals used for testing purposes.

**Table 8. AC CHARACTERISTICS**  $V_{CC} = 0$  V;  $V_{EE} = -3.465$  V to -2.375 V or  $V_{CC} = 2.375$  V to 3.465 V;  $V_{EE} = 0$  V  $V_{CC} = 2.375$  V or  $V_{CC} = 2.375$  V to  $V_{CC} = 2.375$  V to

				-40°C		25°C 85°C						
Symbol	Characteristic		Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
V <sub>OUTPP</sub>	Output Voltage Amplitude f (See Figure 4) (Note 15) f in	i <sub>n</sub> < 7 GHz 1 < 10 GHz	300 200	400 250		300 200	400 250		300 100	400 150		mV
t <sub>PLH</sub> , t <sub>PHL</sub>	Propagation Delay to Output Differential		90	110	150	100	120	150	100	125	155	ps
t <sub>SKEW</sub>	Duty Cycle Skew (Note 16)			3	15		3	15		3	15	ps
UITTER	Peak-to-Peak Data Dependent Jitter (No	n < 10 GHz te 19) l < 10 Gb/s		0.2 8	1 15		0.2 8	1 15		0.2 8	1.0 15	ps
V <sub>INPP</sub>	Input Voltage Swing/Sensitivity (Differential Configuration) (Note 17)		75		2500	75		2500	75		2500	mV
t <sub>r</sub>	Output Rise/Fall Times @ 1 GHz (20% - 80%)	Q, $\overline{Q}$	21	35	53	21	35	53	21	35	53	ps

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

- 15. Measured using a 400 mV source, 50% duty cycle clock source. All loading with 50  $\Omega$  to  $V_{CC}$ . Input edge rates 40 ps (20% 80%).
- 16. See Figure 5 t<sub>skew</sub> = |t<sub>PLH</sub> t<sub>PHL</sub>| for a nominal 50% differential clock input waveform.

  17. V<sub>INPP(max)</sub> cannot exceed V<sub>CC</sub> V<sub>EE</sub>. (Applicable only when V<sub>CC</sub> V<sub>EE</sub> < 2500 mV). Input voltage swing is a single-ended measurement operating in differential mode.
- 18. Additive RMS jitter with 50% duty cycle clock signal at 10GHz.
- 19. Additive Peak-to-Peak data dependent jitter with NRZ PRBS2<sup>31</sup>-1 data rate at 10 Gb/s.

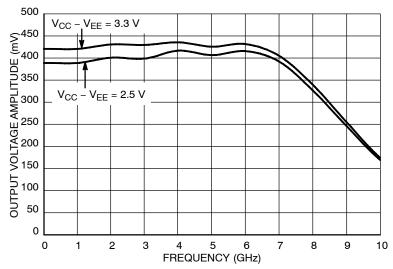


Figure 4. Output Voltage Amplitude (V<sub>OUTPP</sub>) versus Input Clock Frequency (fin) at Ambient Temperature (Typical)

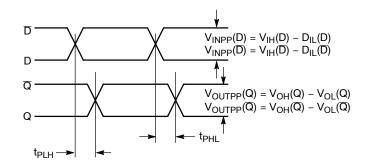


Figure 5. AC Reference Measurement

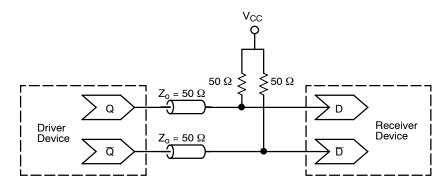


Figure 6. Typical Termination for Output Driver and Device Evaluation (Refer to Application Note AND8020 – Termination of ECL Logic Devices)

## **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>			
NBSG16MMN	QFN-16	123 Units / Rail			
NBSG16MMNG	QFN-16 (Pb-Free)	123 Units / Rail			
NBSG16MMNR2	QFN-16	3000 / Tape & Reel			
NBSG16MMNR2G	QFN-16 (Pb-Free)	3000 / Tape & Reel			

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

## **Application Information**

All inputs can accept PECL, CML, and LVDS signal levels. The input voltage can range from  $V_{CC}$  to 1.2 V.

Examples interfaces are illustrated below in a 50  $\Omega$  environment (Z = 50  $\Omega$ ).

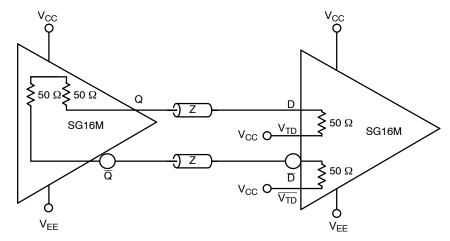


Figure 7. CML to CML Interface

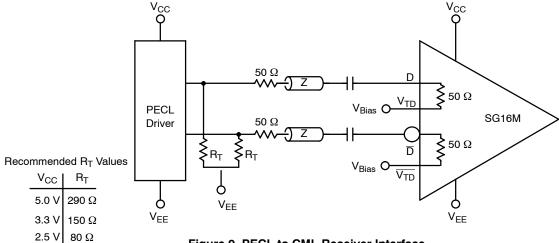


Figure 9. PECL to CML Receiver Interface

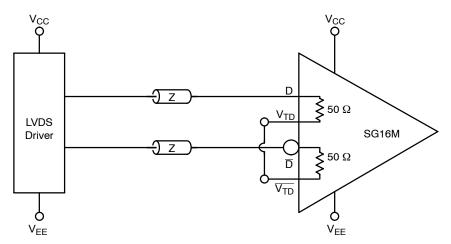
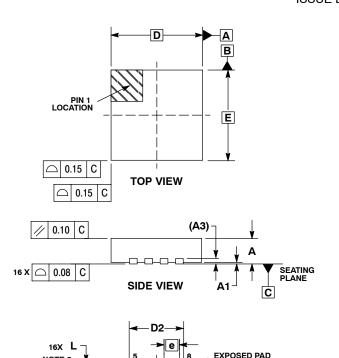


Figure 8. LVDS to CML Receiver Interface

#### PACKAGE DIMENSIONS

#### 16 PIN QFN CASE 485G-01 **ISSUE B**



**E2** 

е

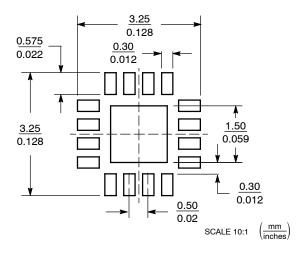
#### NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- CONTROLLING DIMENSION: MILLIMETERS.
  DIMENSION & APPLIES TO PLATED
- TERMINAL AND IS MEASURED BETWEEN 0.25 AND 0.30 MM FROM TERMINAL.
- COPLANARITY APPLIES TO THE EXPOSED
- PAD AS WELL AS THE TERMINALS.

  L<sub>max</sub> CONDITION CAN NOT VIOLATE 0.2 MM
  MINIMUM SPACING BETWEEN LEAD TIP AND FLAG

	MILLIN	IETERS				
DIM	MIN	MAX				
Α	0.80	1.00				
A1	0.00	0.05				
А3	0.20	REF				
b	0.18	0.30				
D	3.00	BSC				
D2	1.65	1.85				
Е	3.00	BSC				
E2	1.65	1.85				
е	0.50	BSC				
K	0.20					
L	0.30	0.50				

#### **SOLDERING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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